

#### **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
N. Channel	<u> </u>	$0.3\Omega @ V_{GS} = 10V$	1.8A
N-Channel	60V	0.45Ω @ V <sub>GS</sub> = 4.5V	1.4A
D. Ohannah	00)/	0.425Ω @ V <sub>GS</sub> = -10V	-1.5A
P-Channel	-60V	0.63Ω @ V <sub>GS</sub> = -4.5V	-1.2A

### Description

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

SM-8

### **Applications**

- DC Motor Control
- DC-AC Inverters

#### Features

- 2 x N + 2 x P Channels in a SOIC Package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SM-8 (8 LEAD SOT223)
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram

S<sub>1</sub>

 $S_2$ 

• Terminals: Finish — Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 3

S4

 $S_3$ 

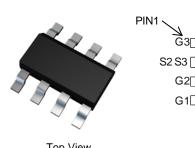
Internal Schematic

G₄

D<sub>3</sub>, D<sub>4</sub>

Weight: 0.117 grams (Approximate)

D<sub>1</sub>, D<sub>2</sub>





## Ordering Information (Note 4)

Part Number	Reel Size	Tape Width	Quantity Per Reel
ZXMHC6A07T8TA	7"	12mm	1,000 units
ZXMHC6A07T8TC	13"	12mm	4,000 units

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

Top View Pin

Configuration

and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

∃G4

D3 D4

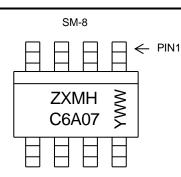
S1 S4

D1 D2

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

Notes:



ZXMHC6A07 = Product Type Marking Code YWW = Date Code Marking Y or  $\overline{Y}$  = Last Digit of Year (ex: 5= 2015) WW or  $\overline{WW}$  = Week Code (01~53)



## **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	N-channel	P-channel	Units		
Drain-Source Voltage	V <sub>DSS</sub>	60	-60	V		
Gate-Source Voltage	V <sub>GSS</sub>	±20	±20	V		
Continuous Drain Current, $V_{GS} = 10V$ (Note 8)Steady State $T_A = +25^{\circ}C$ (Note 6) $T_A = +70^{\circ}C$ (Note 6) $T_A = +25^{\circ}C$ (Note 5)				1.8 1.4 1.6	-1.5 -1.2 -1.3	A
Maximum Body Diode Forward Current (Note 6)	Is	2.3	-2.1	А		
Pulsed Drain Current (Note 7)			I <sub>DM</sub>	8.4	-7.2	А
Pulsed Source Current (Note 7)				8.4	-7.2	А

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 8) Linear Derating Factor	T <sub>A</sub> = +25°C (Note 5)	PD	1.3 10.4	W mW/°C
Total Power Dissipation (Note 8) Linear Derating Factor	T <sub>A</sub> = +25°C (Note 6)	PD	1.7 13.6	W mW/°C
Thermal Resistance, Junction to Ambient (Note 8)	Steady State (Note 5)	P	94.5	°C/W
mermai Resistance, Junction to Ambient (Note 6)	Steady State (Note 6)	R <sub>θJA</sub>	73.3	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

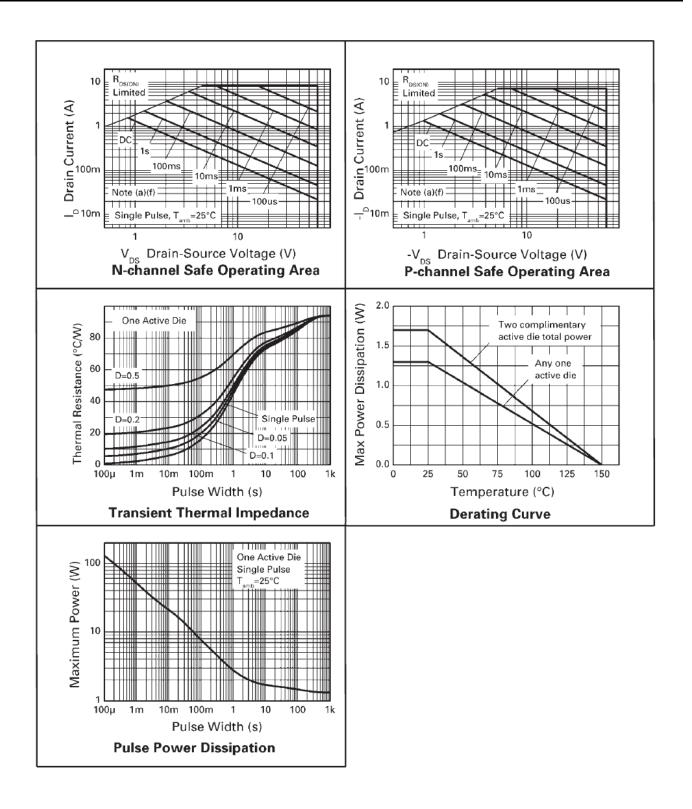
5. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions, with the heat sink Notes: split into two equal areas one for each drain connection.

6. For a device surface mounted on FR4 PCB measured at t ≤10 seconds.

7. Repetitive rating 50mm x 50mm x 1.6mm FR4 PCB, D = 0.02, pulse width 300µs - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph. 8. For device with one active die.



## **Typical Characteristics**





#### Electrical Characteristics N-CHANNEL (@TA = +25°C, unless otherwise specified.)

	(- // -	,		•	/	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 10)						-
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		—	1.0	μA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>			100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 10)				-		
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0	_	3.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
Static Drain-Source On-Resistance (Note 9)	Deserver		—	0.3	Ω	$V_{GS} = 10V, I_D = 1.8A$
Static Drain-Source On-Resistance (Note 9)	R <sub>DS</sub> (ON)		—	0.45	12	$V_{GS} = 4.5V, I_D = 1.3A$
Forward Transfer Admittance (Notes 9 & 11)	<b>g</b> fs	_	2.3	_	S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 1.8A
Diode Forward Voltage (Note 9)	V <sub>SD</sub>	_	0.85	0.95	V	$T_J = +25^{\circ}C, V_{GS} = 0V,$ $I_S = 0.45A$
DYNAMIC CHARACTERISTICS (Note 11)	I				1	<u> </u>
Input Capacitance	C <sub>iss</sub>	_	166	—	pF	$V_{DS} = 40V, V_{GS} = 0V,$ f = 1MHz
Output Capacitance	Coss	_	19.5	—		
Reverse Transfer Capacitance	Crss	_	8.7	_		
Gate Charge (V <sub>GS</sub> = -5.0V)	Qq		1.65	—	nC	
Total Gate Charge (V <sub>GS</sub> = -10V)	Q <sub>q</sub>		3.2	—		V <sub>DS</sub> = 30V, I <sub>D</sub> = 1.8A
Gate-Source Charge	Q <sub>gs</sub>		0.67	_	nC	
Gate-Drain Charge	Q <sub>gd</sub>		0.82	—		
Turn-On Delay Time	t <sub>D(on)</sub>		1.8	_		$V_{DD} = 30V, V_{GS} = 10V, \\ I_D = 1.8A, \ R_G = 6.0\Omega$
Turn-On Rise Time	tr	_	1.4	—	ns	
Turn-Off Delay Time	t <sub>D(off)</sub>	_	4.9	—		
Turn-Off Fall Time	tf	_	2.0	_		
Reverse Recovery Time	t <sub>rr</sub>	_	20.5	—	ns	T <sub>J</sub> = +25°C, I <sub>S</sub> = 1.8A,
Reverse Recovery Charge	Qrr	_	21.3	_	nC	$di/dt = 100A/\mu s$

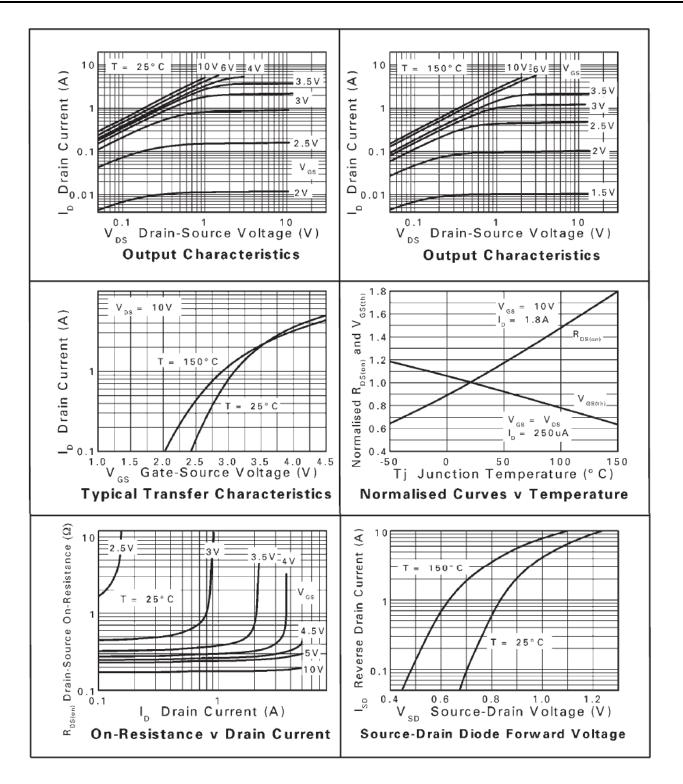
## Electrical Characteristics P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 10)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-60	—	_	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		—	-1.0	μA	$V_{DS} = -60V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	—	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 10)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1.0	_	_	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	
Static Drain-Source On-Resistance (Note 9)		_	—	0.425	Ω	V <sub>GS</sub> = -10V, I <sub>D</sub> = -0.9A	
Static Dialit-Source Off-Resistance (Note 9)	R <sub>DS</sub> (ON)	_	_	0.63	12	$V_{GS} = -4.5V, I_D = -0.8A$	
Forward Transfer Admittance (Notes 9 & 11)	<b>g</b> fs	_	1.8	—	S	V <sub>DS</sub> = -15V, I <sub>D</sub> = -0.9A	
Diode Forward Voltage (Note 9)	V <sub>SD</sub>	—	-0.85	-0.95	V	$T_J = +25^{\circ}C, V_{GS} = 0V,$ $I_S = -0.8A$	
DYNAMIC CHARACTERISTICS (Note 11)	•						
Input Capacitance	Ciss		233		pF	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss	_	17.4	_	pF		
Reverse Transfer Capacitance	Crss		9.6	_	pF		
Gate Charge (V <sub>GS</sub> = -5.0V)	Qg		2.4		nC		
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg		5.1	_	nC		
Gate-Source Charge	Q <sub>gs</sub>	_	0.7	-	nC	$V_{DS} = -30V, I_D = -0.9A,$	
Gate-Drain Charge	Q <sub>gd</sub>	_	0.7	_	nC		
Turn-On Delay Time	t <sub>D(on)</sub>	_	1.6	-	ns		
Turn-On Rise Time	tr	—	2.3	—	ns	$V_{DD} = -30V, V_{GS} = -10V,$	
Turn-Off Delay Time	t <sub>D(off)</sub>	—	13	—	ns	$R_{G} = 6.0\Omega, I_{D} = -1.0A$	
Turn-Off Fall Time	t <sub>f</sub>	_	5.8		ns	1	
Reverse Recovery Time	t <sub>rr</sub>	—	22.6	—	ns		
Reverse Recovery Charge	Q <sub>rr</sub>	—	23.2	—	nC	$T_J = +25^{\circ}C$ , $I_S = -0.9A$ , $di/dt = 100A/\mu s$	

 9. Measured under pulsed conditions. Width≤300µs. Duty cycle ≤ 2%.
10. Short duration pulse test used to minimize self-heating effect.
11. Guaranteed by design. Not subject to product testing. Notes:

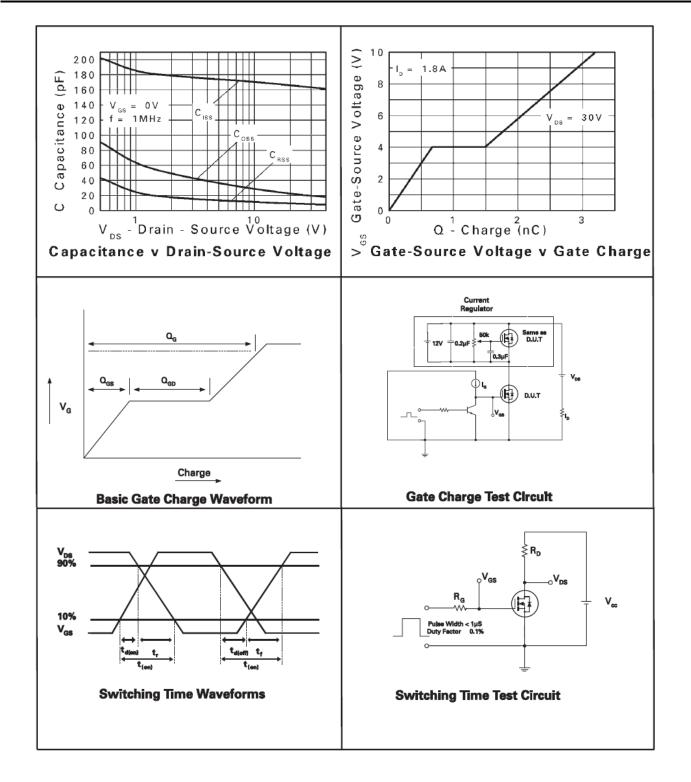


## **Typical Characteristics (N-Channel)**



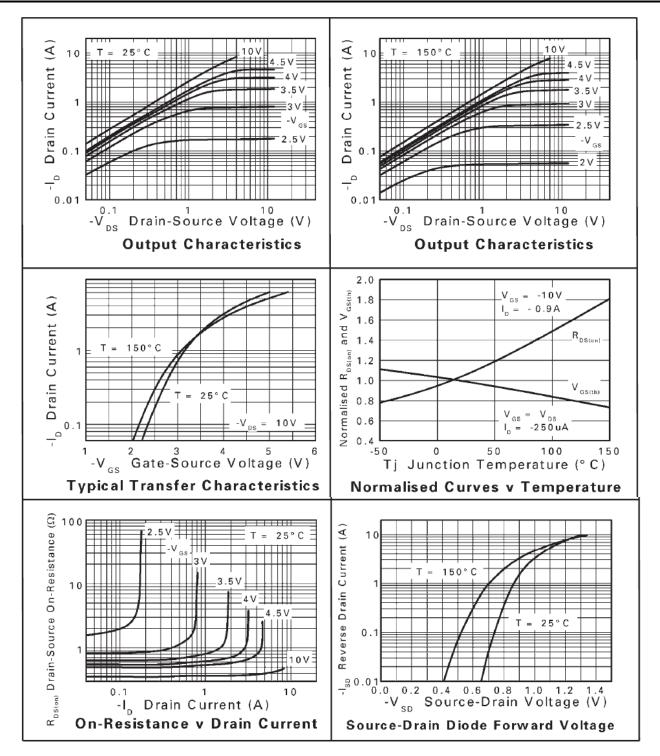


## **Typical Characteristics (N-Channel)**



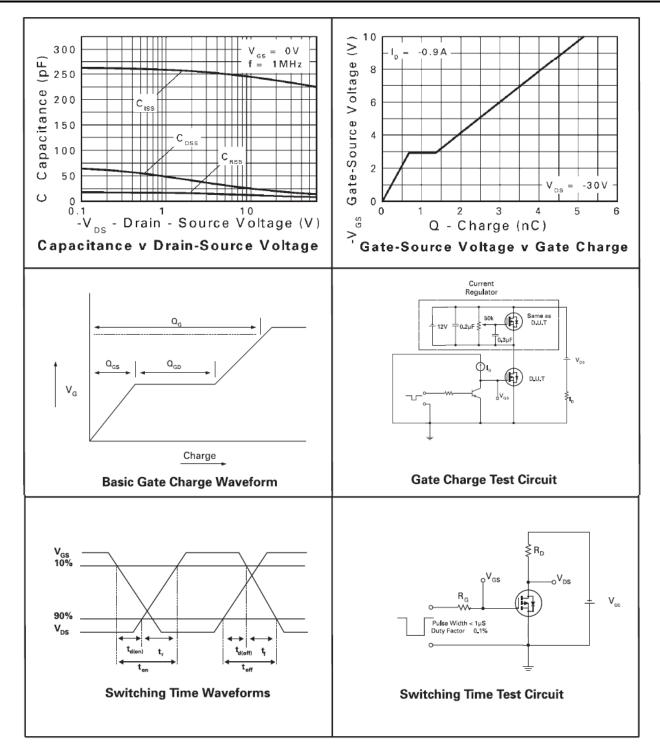


## **Typical Characteristics (P-Channel)**





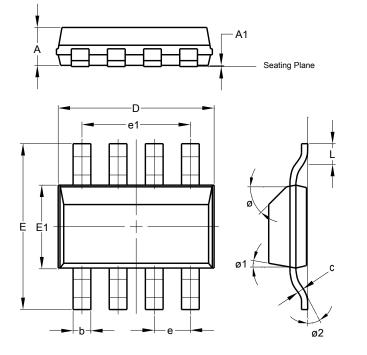
## **Typical Characteristics (P-Channel)**





#### **Package Outline Dimensions**

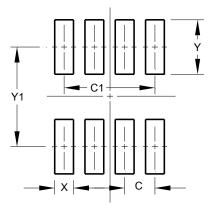
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SM-8							
Dim	Min Max Typ						
Α	-	1.70	1.60				
A1	0.02	0.10	0.04				
b	0.70	0.90	0.80				
С	0.24	0.32	0.28				
D	6.30	6.30 6.70 6.60					
е	1.53 REF						
e1	4.59 REF						
E	6.70 7.30 7.00						
E1	3.30	3.70	3.50				
L	0.75 1.00 0.90						
Ø	45°						
Ø1	15°						
Ø2			10°				
All I	All Dimensions in mm						

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.52
C1	4.60
Х	0.95
Y	2.80
Y1	6.80



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